



SMD Comm X8G HT150C Flex, Ceramic, 2.4 pF, +/-0.5 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1206, 1.5 mm



| General Information | |
|--------------------------|--|
| Series | SMD Comm X8G HT150C Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 15 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | |
|------------|------------------|
| Chip Size | 1206 |
| L | 3.3mm +/-0.4mm |
| W | 1.6mm +/-0.35mm |
| Т | 0.78mm +/-0.20mm |
| S | 1.5mm MIN |
| В | 0.6mm +/-0.25mm |
| | |

| Packaging Specifications | |
|--------------------------|------------------|
| В | 0.6mm +/-0.25mm |
| S | 1.5mm MIN |
| Т | 0.78mm +/-0.20mm |

10000

Packaging

Packaging Quantity

T&R, 330mm, Plastic Tape

| Specifications | |
|--|--|
| Capacitance | 2.4 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | +/-0.5 pF |
| Voltage DC | 250 VDC |
| Dielectric Withstanding Voltage | 625 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

| Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitut | te - and |
|--|----------|
| we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have | nave the |
| requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provide | ed by us |
| with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained. | • |

Generated 05/03/2025 © 2006 - 2025 YAGEO